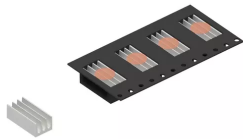


Data sheet Product ICK SMD A 13 MI B TR



Heatsinks and active heatsinks for processors>Heatsinks for DIL-IC, PLCC and SMD

10 x 6 mm, for SMD components and others

Features

case type:	SMD
thermal resistance:	63 K/W
surface:	solderable surface
diameter of tape:	330 mm
width of belt:	24 mm
quantity per reel:	1,000

Technical Drawing

